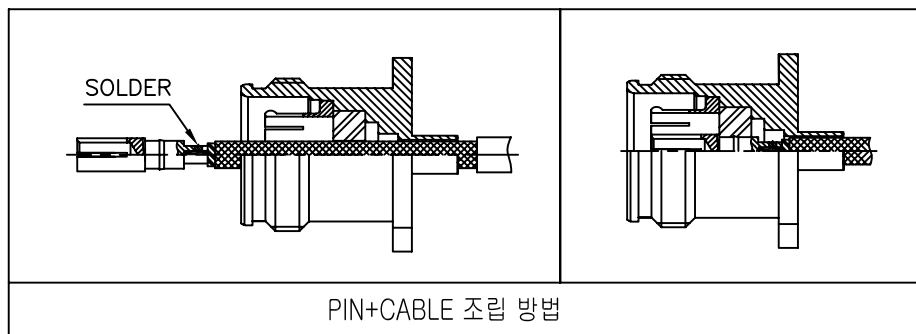
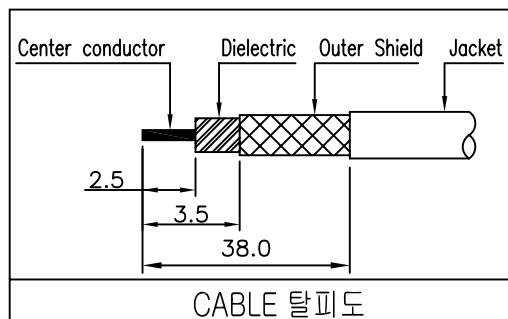
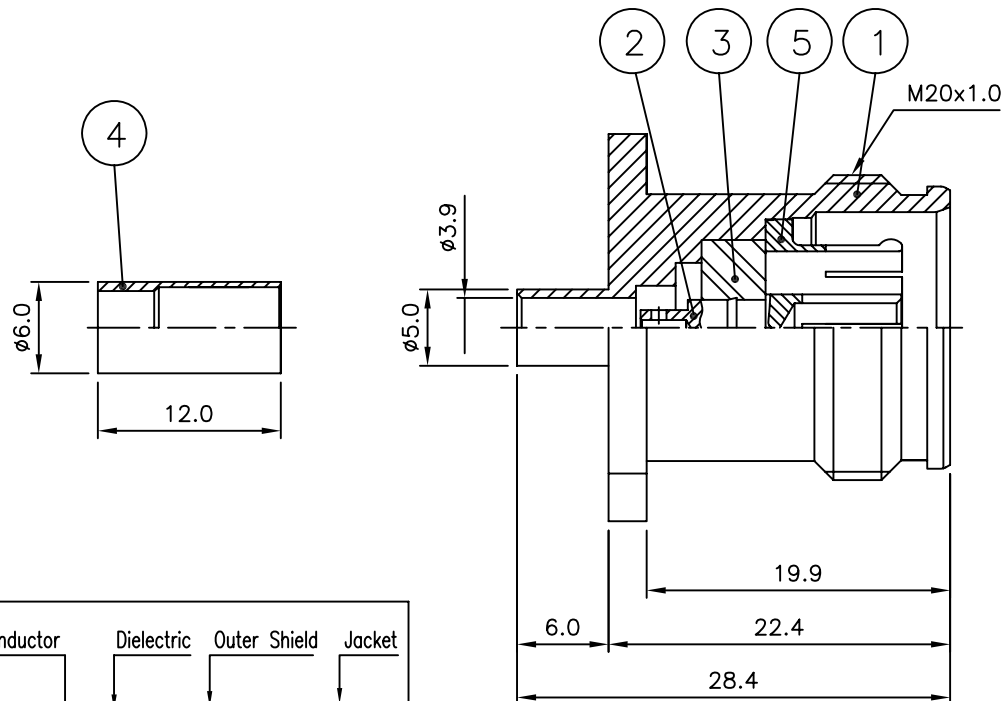
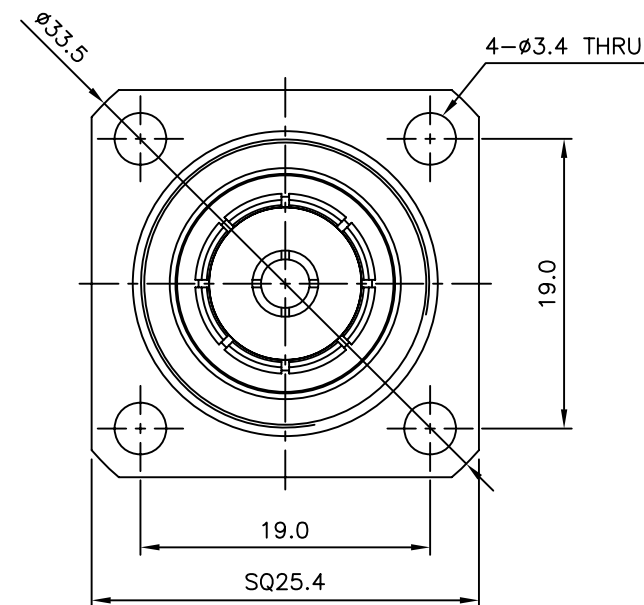


※ PIN 조립하지 말것



REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2017. 09. 28.
↑	[설번No.201710-0008] 설계 오류로 인한 내부 구조 변경	S.Y.EUN	I.C.KIM	2017. 10. 23.



5	JACK	1	MBsBD C3604BD-F	Nickel Plate	DJA00228-5/9
4	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00199-5/1
3	INSULATOR	1	TEFLON		DIN02811-N/3 DIN02811-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03739-5/3 DCT03739-5/2
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04357-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2 Angle ±1°	DATE 2017. 10. 23.	 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
MATERIAL		APPROVED BY I.C.KIM	
FINISH		CHECKED BY	TITLE 4.3/10 DIN50 CABLE JS-4H 141FJ
		DRAWN BY S.Y.EUN	DWG NO. CN03735-7/2
	SCALE 2/1	UNIT mm	REVISION 1
			SHEET 1 of 1